

TECHNICAL SPECIFICATION



**Packaging of components for automatic handling –
Part 6-1: Bulk case packaging for miniaturized surface mounting components**

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**Packaging of components for automatic handling –
Part 6-1: Bulk case packaging for miniaturized surface mounting components**

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CONTENTS

FOREWORD.....	3
INTRODUCTION.....	5
1 Scope.....	6
2 Normative references	6
3 Terms and definitions	6
4 Requirements for the bulk case	6
4.1 Case outline.....	6
4.2 Shutter mechanism	7
4.3 Dimensions	7
4.4 Material	9
4.5 Mechanical characteristics of the bulk case	10
4.5.1 Mechanical stability	10
4.5.2 Performance and test methods	10
5 Marking of the bulk case.....	10
5.1 General.....	10
5.2 Recycling	10
Annex A (informative) Packing capacity	11
A.1 Component types	11
A.2 Component quantities	11
Annex B (informative) Label information.....	12
B.1 Label material	12
B.2 Label adhesion	12
B.3 Label content	12
Annex C (informative) Examples of requirements and test methods	13
Bibliography.....	14
Figure 1 – Bulk case – General view	7
Figure 2 – Bulk case – Photographic view.....	7
Figure 3 – Dimensions of the bulk case.....	8
Figure B.1 – Example of a label with bar code	12
Figure B.2 – Example of a label with a 2D symbol.....	12
Figure B.3 – Example of a label with bar code and a 2D symbol	12
Table 1 – Size codes for components	6
Table 2 – Dimension of the bulk case	9
Table A.1 – Typical quantities of Capacitors in the bulk case	11
Table A.2 – Typical quantities of Resistors in the bulk case	11
Table C.1 – Examples of requirements and test methods for the bulk case	13

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IEC TS 60286-6-1 has been prepared by IEC technical committee 40: Capacitors and resistors for electronic equipment. It is a Technical Specification.

The text of this Technical Specification is based on the following documents:

Draft	Report on voting
40/3038/DTS	40/3066/RVDTS

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this Technical Specification is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at https://www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at <https://www.iec.ch/standardsdev/publications>.

A list of all parts in the IEC 60286 series, published under the general title *Packaging of components for automatic handling*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

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- withdrawn,
- replaced by a revised edition, or
- amended.

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INTRODUCTION

This Technical Specification was developed by the Technical Committee 40 Working group 36 on Components Packaging, in which the members such as assembly machine manufacturers, component manufacturers and packaging material manufacturers had proposed, considered and discussed the possible standardization on the application of a new type of bulk case to contain smaller sizes of SMD, aiming to supplement IEC 60286-6 Edition 2.0, issued in 2004.

NOTE For size limitations of components, see Annex A, Table A.1 and Table A.2.

The International Electrotechnical Commission (IEC) draws attention to the fact that it is claimed that compliance with this document may involve the use of a patent concerning “storage case for surface mounting electronic components”¹.

IEC takes no position concerning the evidence, validity and scope of this patent right.

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¹ Patent Application No.: PCT/JP2021/023093, published 17.06.2021

PACKAGING OF COMPONENTS FOR AUTOMATIC HANDLING –

Part 6-1: Bulk case packaging for miniaturized surface mounting components

1 Scope

This part of IEC 60286 specifies a bulk case capable of containing miniaturized surface mount components of sizes within the range of 0402M to 1005M (see Table 1 for explanation of the codes). The bulk case is designed for transport and storage of components and to supply of components directly or by an appropriate feeder to the placement machine. The bulk case is equipped with a coupling interface to enable its automatic handling, e.g. by a robot or automatic handling machines.

2 Normative references

There are no normative references in this document.

3 Terms and definitions

For the purposes of this document, the following terms and definitions apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at <https://www.electropedia.org/>
- ISO Online browsing platform: available at <https://www.iso.org/obp>

3.1

component size

<metric> component dimensions expressed by a metric code

Note 1 to entry: For identification the size code is followed by a capital M.

Note 2 to entry: For comparison with inch-based size codes, an equivalency table is shown in Table 1.

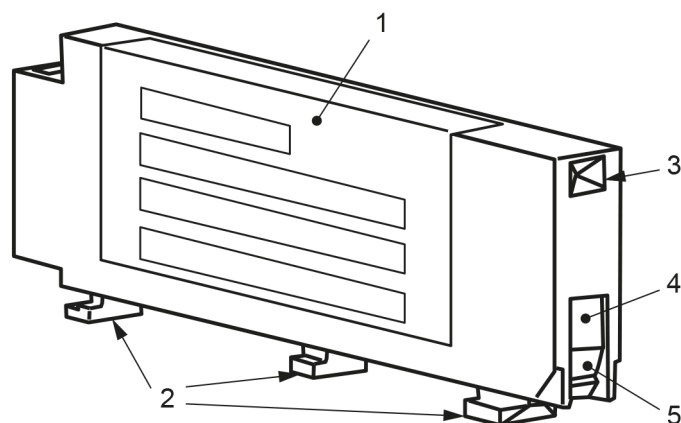
Table 1 – Size codes for components

Metric size code	Inch size code
0402M	01005
0603M	0201
1005M	0402

4 Requirements for the bulk case

4.1 Case outline

Figure 1 shows the general outline of the bulk case. Figure 2 shows the photographic view of the bulk case.

**Key**

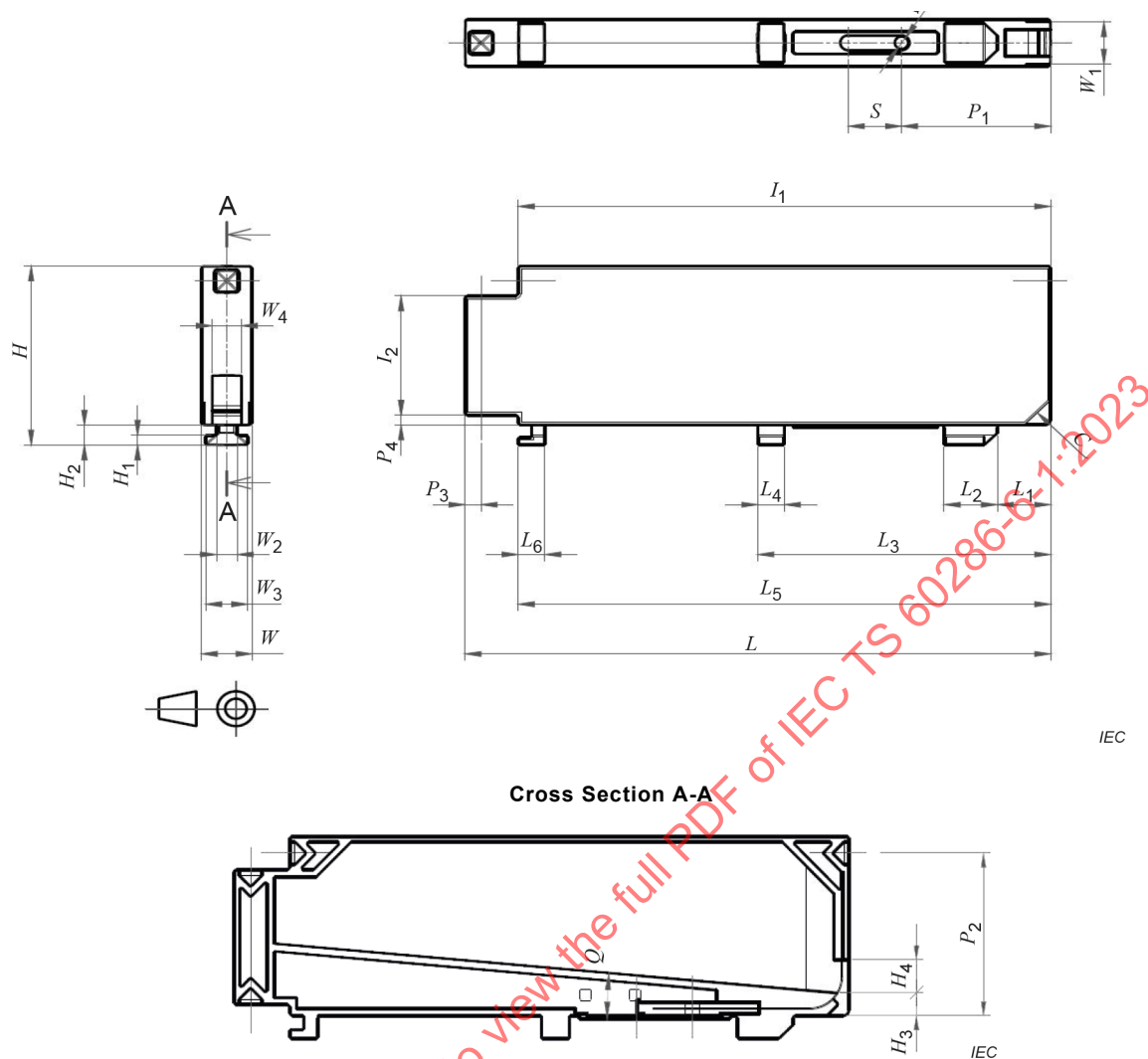
- 1 Label
- 2 Coupling interface (T-Slot bar)
- 3 Chuck hole
- 4 Shutter mechanism
- 5 Access hole

Figure 1 – Bulk case – General view**Figure 2 – Bulk case – Photographic view****4.2 Shutter mechanism**

The bulk case shall have a slide combined with a shutter to open and close the access hole. After an identity check to prevent unintended mixing of components, the shutter can be opened by a tool connected to the actuating hole.

4.3 Dimensions

A general description and letter symbols for individual dimensions are given in Figure 3 and Table 2.



Key:

L, L_1 to L_6 : Length

H, H_1 to H_4 : Height

W, W_1 to W_4 : Width

S : Slide length

P_1 to P_4 : Distance from bottom to chucking hole, etc.

φD : Diameter of actuating hole

Details: See Table 2

Figure 3 – Dimensions of the bulk case

Table 2 – Dimension of the bulk case

Symbol	Description	Dimension mm	Angle (°)
C	Connection chamfer	$5,0 \pm 0,2$	-
D	Diameter of actuating hole	$2,7 \pm 0,2$	-
H	Height	$36,0 \pm 0,5$	-
H_1	Height of T-slot bottom	$2,0 \pm 0,1$	-
H_2	Height of T-slot top	$4,0 \pm 0,1$	-
H_3	Distance from bottom to access hole in the direction H	4 ^a	-
H_4	Height of access hole in the direction H	6 ^a	-
I_1	Chucking distance in the direction L	$100,0 \pm 0,5$	-
I_2	Chucking distance in the direction H	$24,0 \pm 0,2$	-
L	Length	$110,0 \pm 0,5$	-
L_1	Distance from tip to first T-slot	$10,0 \pm 0,1$	-
L_2	Length of first T-slot	$10,0 \pm 0,1$	-
L_3	Length of distance from tip to second T-slot	$55,0 \pm 0,2$	-
L_4	Length of second T-slot	$5,0 \pm 0,1$	-
L_5	Distance from tip to third T-slot	$100,0 \pm 0,3$	-
L_6	Length of third T-slot	$5,0 \pm 0,1$	-
P_1	Slide start position (access hole completely close)	$28,0^{+0}_{-0,2}$	-
P_2	Distance from bottom to chucking hole in the direction H	$29,00 \pm 0,08$	-
P_3	Distance from tip to chucking hole in the direction L	$3,0 \pm 0,3$	-
P_4	Distance from bottom to chucking block in the direction H	$2,0 \pm 0,3$	-
Q	Slope angle	-	5 ^a
S	Slide length	$10^{+0,5}_{-0}$ ^a	-
W	Width	$9,5^{+0}_{-0,2}$	-
W_1	Connection width	$8,5 \pm 0,1$	-
W_2	Width of T-slot bottom	$7,9 \pm 0,1$	-
W_3	Width of T-slot Top	$3,9 \pm 0,1$	-
W_4	Width of access hole in the direction W	5,5 ^a	-
^a Recommended value			

4.4 Material

The material of the bulk case shall be transparent or translucent. The bulk case material shall not adversely affect the mechanical and electrical characteristics, solderability, or marking of the devices during or after transport and storage. The materials shall be selected to avoid damage to electrostatic-sensitive components.

4.5 Mechanical characteristics of the bulk case

4.5.1 Mechanical stability

Mechanical stability of loaded bulk cases shall be such that during transport, storage and use the dimensions remain within its tolerances, and that the components are retained without damage and can be easily removed.

4.5.2 Performance and test methods

Annex C shows examples of test methods for the robustness of the bulk case in view of its mechanical characteristics.

See Annex C, Table C.1.

5 Marking of the bulk case

5.1 General

The bulk case shall provide space for a peelable label. The label shall be fixed onto the sides, or side and tops as shown in Figure 1.

The marking on the label shall comply with the requirements of the detail specification of the component.

The label style and content should be in accordance with IEC 62090. The labels on the packaging of electronic components applies for automatic handling Business to Business processes. The data elements shall be represented on the label as human-readable text and shall be encoded in machine-readable form, either linear bar code or two-dimensional(2D) symbols, or a combination of both. The label format accommodates mandatory, optional and mutually agreed data elements.

See Annex B for additional information on labels.

5.2 Recycling

Bulk cases defined in Figure 1 and Figure 2 shall be permanently and visibly marked with an appropriate recycling symbol. ISO 11469 is recommended.

Annex A (informative)

Packing capacity

A.1 Component types

This packing type can apply to small sized surface mounting devices, for example certain capacitors, resistors and other electronic or electromechanical components.

A.2 Component quantities

Table A.1 and Table A.2 show typical quantities of components contained in a bulk case.

Table A.1 – Typical quantities of Capacitors in the bulk case

Component size	Typical dimensions of components			Typical Quantities pcs
	Length mm	Width mm	Thickness mm	
0402M	0,4	0,2	0,2	500 000
0603M	0,6	0,3	0,3	150 000
1005M	1,0	0,5	0,5	30 000
NOTE The identifier M after the style code indicates a metric dimension base.				

Table A.2 – Typical quantities of Resistors in the bulk case

Component size	Typical dimensions of components			Typical Quantities pcs
	Length mm	Width mm	Thickness mm	
0402M	0,4	0,2	0,13	500 000
0603M	0,6	0,3	0,23	150 000
1005M	1,0	0,5	0,35	30 000
NOTE The identifier M after the style code indicates a metric dimension base.				

Annex B (informative)

Label information

B.1 Label material

The material is not specified. The same material of label is recommended to be used, when the original peelable label is not removed and another label is put over the original one. If a plastic label is used, its material normally is indicated on the label in accordance with ISO 11469.

B.2 Label adhesion

Peelable labels should keep their adhesive properties, if the bulk case is stored at temperatures between $-45\text{ }^{\circ}\text{C}$ to $+70\text{ }^{\circ}\text{C}$ and at a relative humidity between 45 % to 75 %, so that they can be peeled-off prior to re-use of the bulk case.

B.3 Label content

The label style and content should be in accordance with IEC 62090.

Figure B.1 to Figure B.3 show examples of bulk case labels.



Figure B.1 – Example of a label with bar code

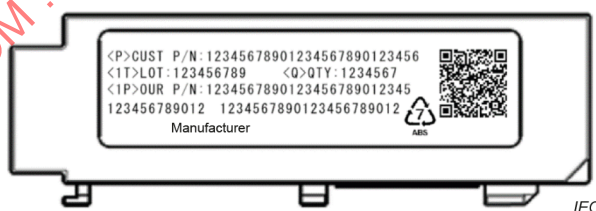


Figure B.2 – Example of a label with a 2D symbol

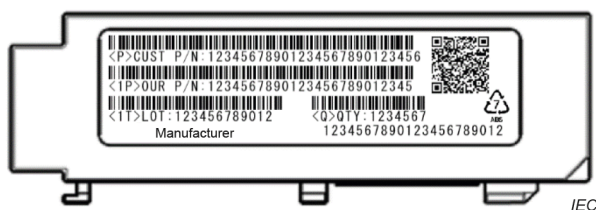


Figure B.3 – Example of a label with bar code and a 2D symbol